| IPC ASSOCIATION ELECTRONIC | © Copyright 2005. | Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved un international and Pan-American copyright conventions. | | nder both | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. | | | | | | | | | | |
|----------------------------------|---|---|---------------------------|---------------------------|---|-------------------------|---------------------|---|-----------|---|--------------------------|---------------------------------|----------------|-----------|--|
| 752-21.1 | IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute | | | | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater | | | | | terials and | ials and Mfg Information | | | | |
| uppliei | r Information | | | | | | | | | | | | | | |
| Company name* | | | | Company unique ID | | | Unique ID Authority | | | | Respo | Response Date* | | | |
| nsemi | | | | | | | | | | | 2024-0 | 2024-05-10 | | | |
| ontact N | ame | Title - Contact | | | I | Phone - Contact* | | | | Email | Email - Contact* | | | | |
| Product-I | Env-Stewards | | Product Enviro Compliance | | | 1 | NA | | | | Prod | Product-Env-Stewards@onsemi.com | | | |
| uthorize | d Representative* | Title - Representative | | | I | Phone - Representative* | | | | Email | Email - Representative* | | | | |
| Product-Env-Stewards Produ | | | | Product Enviro Compliance | | | NA | | | | Prod | Product-Env-Stewards@onsemi.com | | | |
| | Requester Item Number Mfr Ite | | m Number Mfr Item Name | | | | Effective Date | Version | n | Manufacturing Site | | Weight* | UOM | Unit Type | |
| | | 1N5234B 6.2V 500MW 5% Z | | ZENER DO3: | 5 | 2024-05-10 | CN2 | | | 109.66989 | mg | Each | | | |
| lanufa | cturing Process Inform Terminal Plating / Grid Array N | | Terminal Base | Alloy | -STD-020 MS | I Pating | Dank Proc | ess Rody | Tamparatu | ra May Tima at Po | aak Tampa | rotura Numba | r of Paflow Cv | clas | |
| | , , , , , , , , , , , , , , , , , , , | | CU Alloy NA | | | L Katilig | | Peak Process Body Temperature Max Time at O C 30 | | seconds seconds Sumber of Reflow Cycles | | cies | | | |
| omments | , , | | CC Alloy | | 11.3 | | | | | 150 | Isec | onus J | | | |
| omments | • | | | | | | | | | | | | | | |
| or more | information regarding materia | al composition | nlease refer to | n nage 3 | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | Declaration 7 | Гуре * | Detailed | | | | | |
|--|---|--|----------------|---------------------|------------|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). | | | | | | | | | | |
| Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its part and the company acknowledges that Company and the Supplier share provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. | | | | | | | | | | |
| RoHS Declaration * 4 - Item(s | does not contain RoHS restricted substances | per the definition above except for sele | ted exemptions | Supplier Acceptance | * Accepted | | | | | |
| Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound. | | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | |
| Declaration Signature | | | | | | | | | | |
| Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester. | | | | | | | | | | |
| Supplier Digital Signature Ra | astislav Drska | E_ | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|----------|-----------------|----------|--|------------------|--------|--------|-----------------|
| CSS Wire | 75.0 | mg | Supplier | Iron (Fe) | 7439-89-6 | | 63.75 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 11.25 | mg |
| Die | 0.024358 | mg | Supplier | Titanium (Ti) | 7440-32-6 | | 0 | mg |
| | | | Supplier | Silver (Ag) | 7440-22-4 | | 0.0115 | mg |
| | | | Supplier | Silicon (Si) | 7440-21-3 | | 0.0127 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.0001 | mg |
| Dumet Wire | 8.5 | mg | Supplier | Manganese (Mn) | 7439-96-5 | | 0.085 | mg |
| | | | Supplier | Silicon (Si) | 7440-21-3 | | 0.0595 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 2.6775 | mg |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 3.6805 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 1.9975 | mg |
| Glass Encapsulation | 23.5 | mg | Supplier | Boron Trioxide (B2O3) | 1303-86-2 | | 0.705 | mg |
| | | | A | Lead Oxide (PbO) | 1317-36-8 | 7c | 14.382 | mg |
| | | | В | Antimony Trioxide (Sb2O3) | 1309-64-4 | | 0.0118 | mg |
| | | | Supplier | Potassium Monoxide (K2O) | 12136-45-7 | | 0.8813 | mg |
| | | | Supplier | Silica Crystalline (SiO2) | 14808-60-7 | | 7.52 | mg |
| Marking Ink | 0.01953 | mg | Supplier | Titanium Dioxide (TiO2) | 13463-67-7 | | 0.004 | mg |
| | | | Supplier | Formaldehyde, polymer with 4,4-(1-methylethylidene)bisphenol | 25085-75-0 | | 0.0052 | mg |
| | | | Supplier | Proprietary | Proprietary Data | | 0.0009 | mg |
| | | | Supplier | Silica Amorphous (SiO2) | 7631-86-9 | | 0.001 | mg |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.0013 | mg |
| | | | Supplier | Diethylene glycol 2-ethyhexyl-ether | 1559-36-0 | | 0.0025 | mg |
| | | | Supplier | Amino Resin | 68002-20-0 | | 0.0033 | mg |
| | | | Supplier | 2,2,4-Trimethyl-1,3-pentanediol di is Obutyrate | 6846-50-0 | | 0.0013 | mg |
| Plating | 2.626 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 2.626 | mg |